

Features

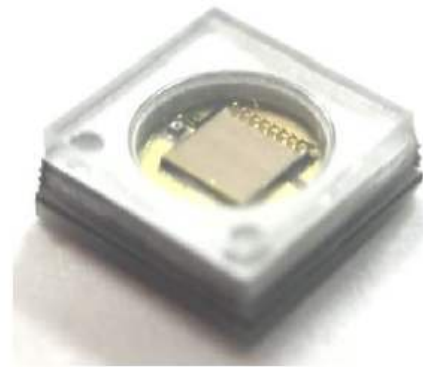
- 3939 IR VCSEL
- ROHS and REACH Compliant
- ESD(HBM) 8KV
- MSL 4 Qualified (J-STD 020)

Applications

- Industrial facility applications
- Consumer Mobile
- Automotive Interior & Exterior
- 3D Sensing(TOF, Structure Light)
- Bio recognition

Description

The INV-Q39CTSHIR is a high-power IR VCSEL. It is a SMD type package which can be used in various applications.



Recommended Solder Pattern

(Suggest Stencil t=0.12 mm)

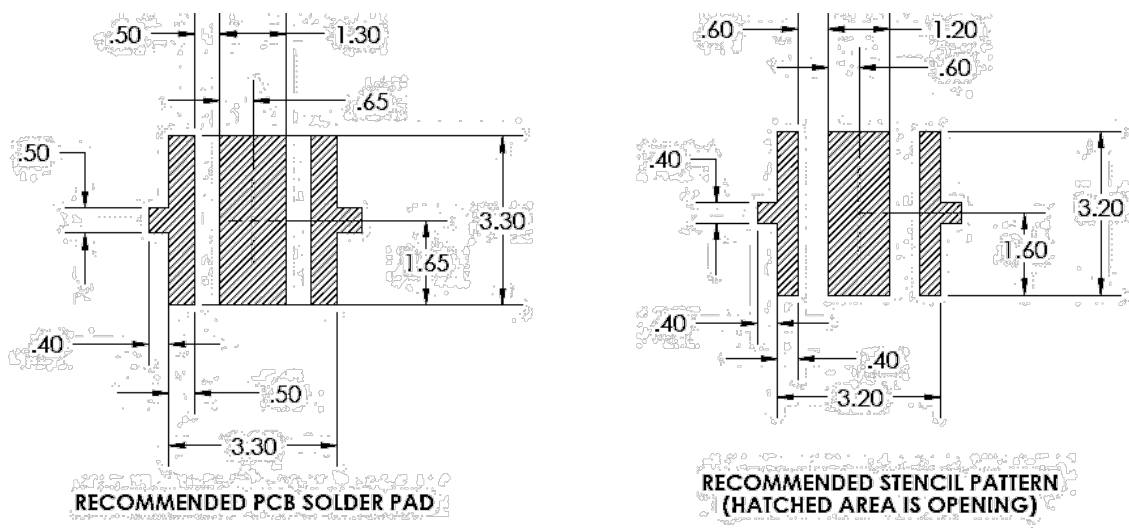


Figure 1. INV-Q39CTSHIR Recommended Solder Pattern

Note:

- * All dimensions are in millimeters.
- * Tolerance is $\pm 0.13\text{mm}$ unless other specified.

Package Dimensions in mm

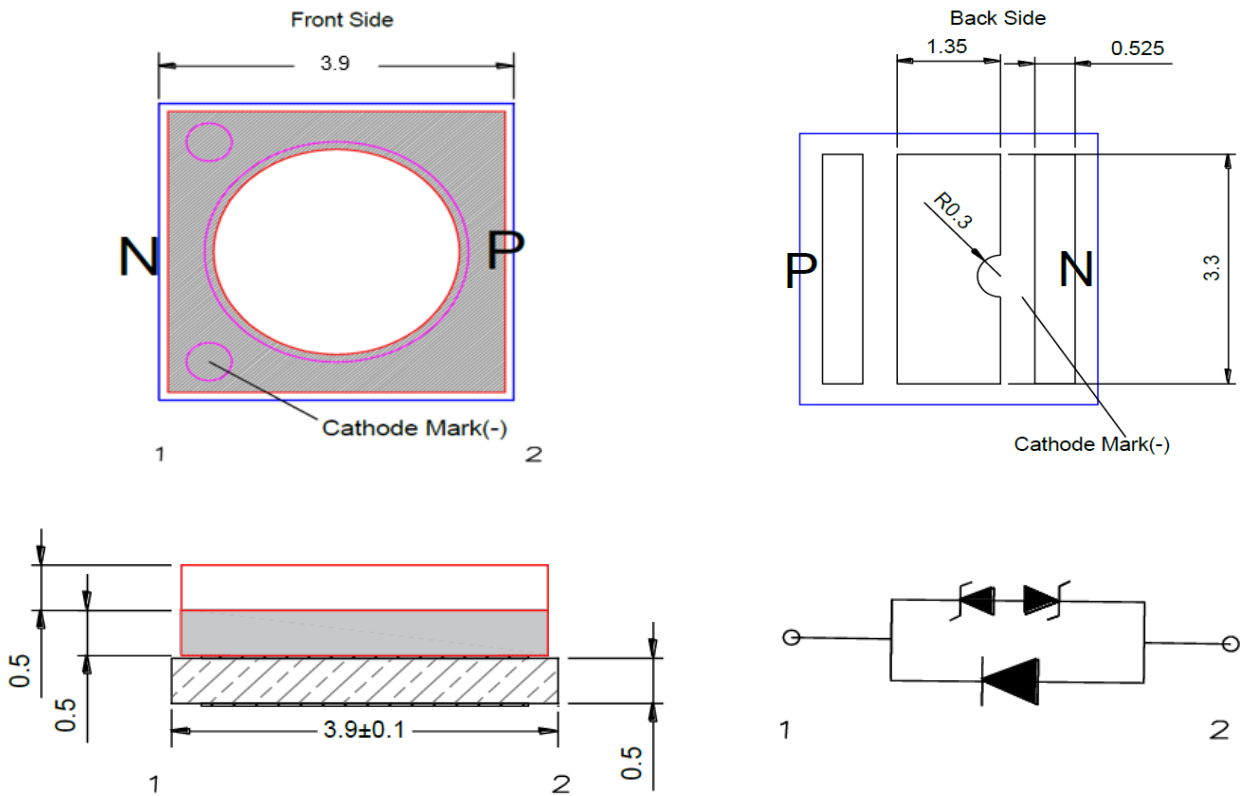


Figure 2. INV-Q39CTSHIR Package Dimensions

***Note**

All dimensions are in millimeters. Tolerance is ± 0.13 mm unless other specified.

Absolute Maximum Rating at 25°C (Note 1)

Product	I _{FP} (mA) max Pulse Current (@1/10 duty)	Pd(W) max	V _R (V) Typ.	T _j (°C) Typ.	T _{ST} (°C)	R _{th} (°C/W)	Soldering Temp. T _{sol} (°C)	ESD HBM (V)
INV-Q39CTSHIR	4000	5.6	-5	110 °C	-40°C~+80°C	8	260 °C	4000

Notes

1. For other ambient, limited setting of current will depend on de-rating curves.
2. D=0.01s duty 1/10.
3. When drive on maximum current , T_j must be kept below 110°C
4. Viewing angle(2θ 1/2) ± 10°

Electrical Characteristics T_A = 25°C (Note 1)

Product	V _F (V)@2000mA		Radiometric Power (mW) @2000mA		Peak Wavelength (nm)		I _R (μA)	View Angle
	min	max	min	max	min	max	Max	2θ 1/2
INV-Q39CTSHIR	1.8	2.8	1500	2200	930	950	10	30

*Notes

1. Performance guaranteed only under conditions listed in above tables.
2. Viewing angle(2θ1/2) ± 10°

ESD Precaution

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly. If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).

Binning Definition (Binning@2000mA)**Power Bin**

Bin Code	Min.	Max.	Unit
P2	1500	2200	mW

Wavelength Bin

Bin Code	Min.	Max.	Unit
W2	930	950	nm

Voltage Bin

Bin Code	Min.	Max.	Unit
V1	1.8	2.2	V
V2	2.2	2.6	
V3	2.6	2.8	

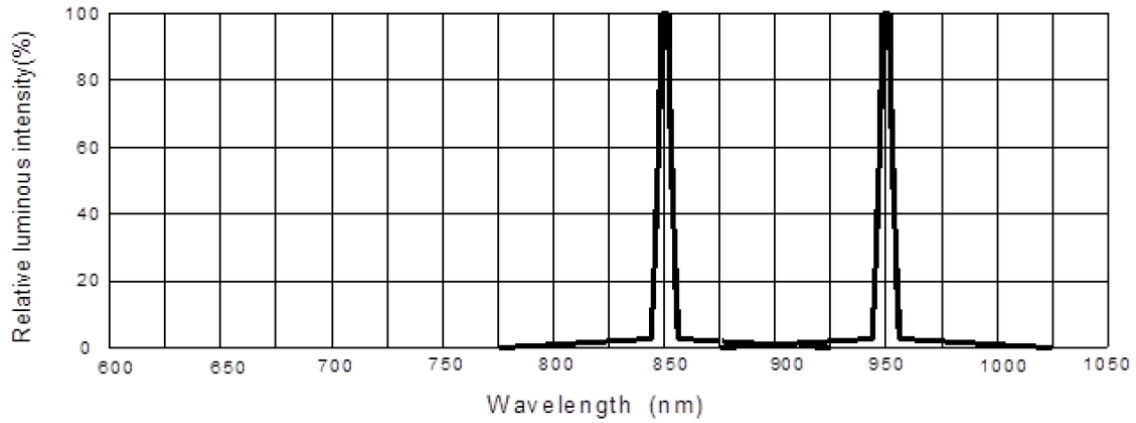
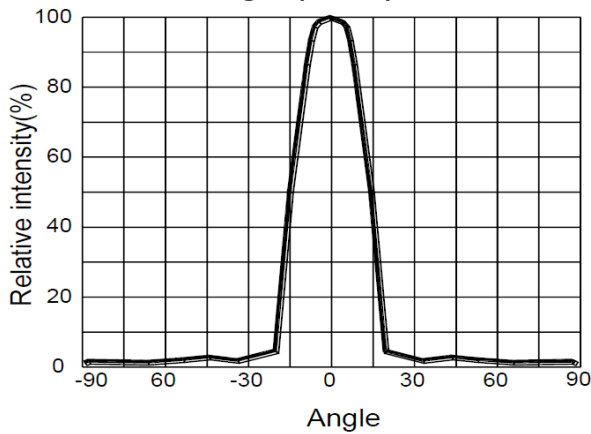
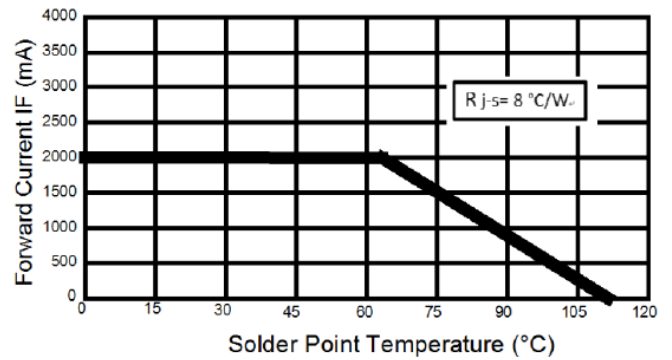
***Notes:**

1. Radiometric Power (P_o) $\pm 10\%$.
2. Wavelength (W_p) $\pm 2.0\text{nm}$
3. Forward voltage (V_f) $\pm 0.12\text{V}$

Electronic-Optical Characteristics

Spectrum Distribution

Spectrum Distribution

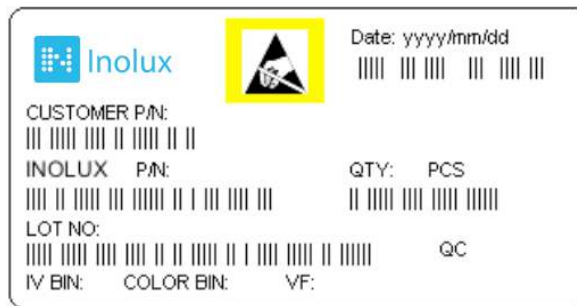

Beam angle (2 θ 1/2) 30D

Thermal Design for De-rating

***Notes:**

 Viewing angle (2 θ 1/2) $\pm 10^\circ$

Ordering Information

Orderable Part Number	Peak Wavelength (nm)	Radiometric Power (mW) @2000mA		Forward Voltage (V) @2000mA		Viewing Angle
		Min	Max	Min	Max	
INV-Q39CTSHIR	940-960	1500	2200	1.8	2.8	30°

Label Specifications



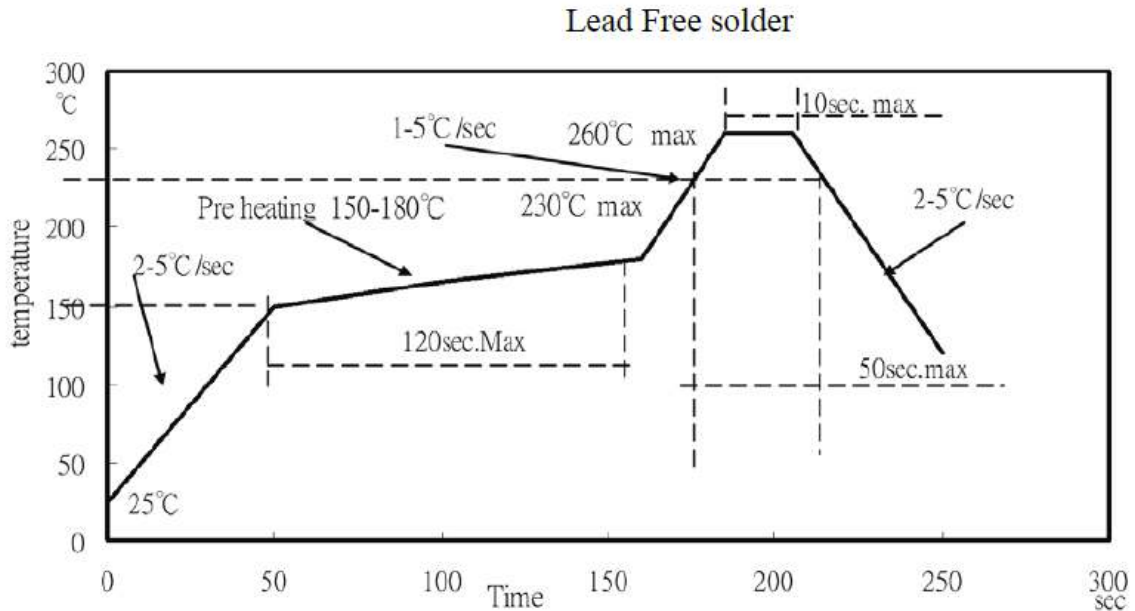
Inolux P/N:

INV	-	Q	3	9	C	T	S		HIR	-	X	X	X	X
Inolux VCSEL		Material	Package		Variation	Orientation	Current	Lens	Color		Customized Stamp-off			
			Q = Quartz Type	39C = 3.9 x 3.9, 120 Deg.			T = Top Mount	S = 2000mA	(Blank) = Clear	HIR = 940nm				

Lot No.:

Z	2	0	1	7	01	24	001
Internal Tracker	Year (2017, 2018,)				Month	Date	Serial

Reflow Soldering



Soldering Iron

Basic Spec is ≤ 4 sec. when 260°C (+10°C → -1 second). Power dissipation of Iron should be less than 15W. Surface temperature should be under 230°C

Rework

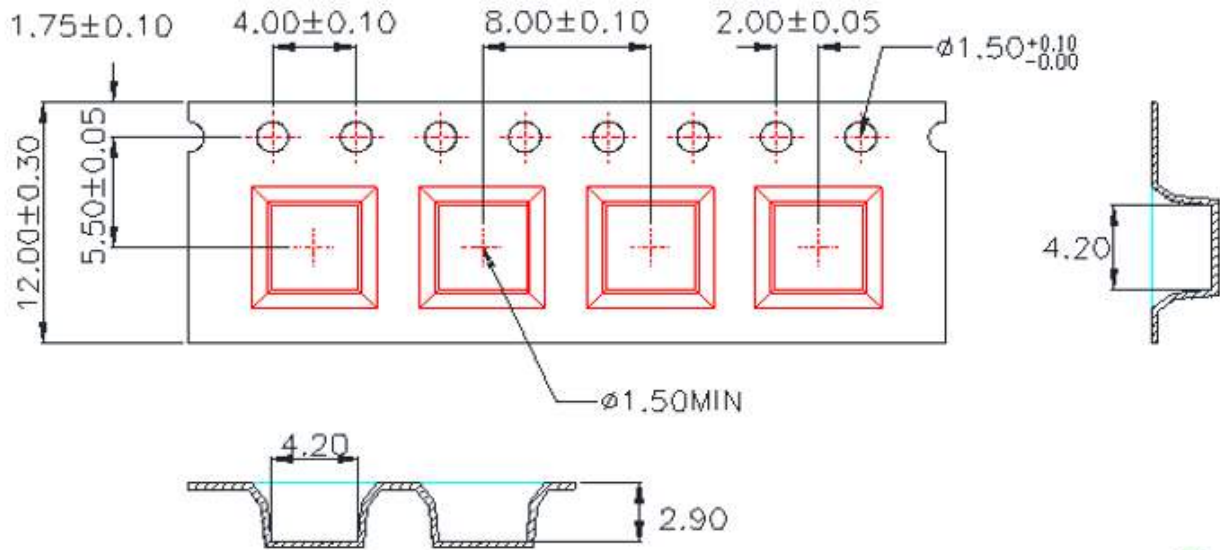
Rework should be completed within 4 second under 245°C

Notes

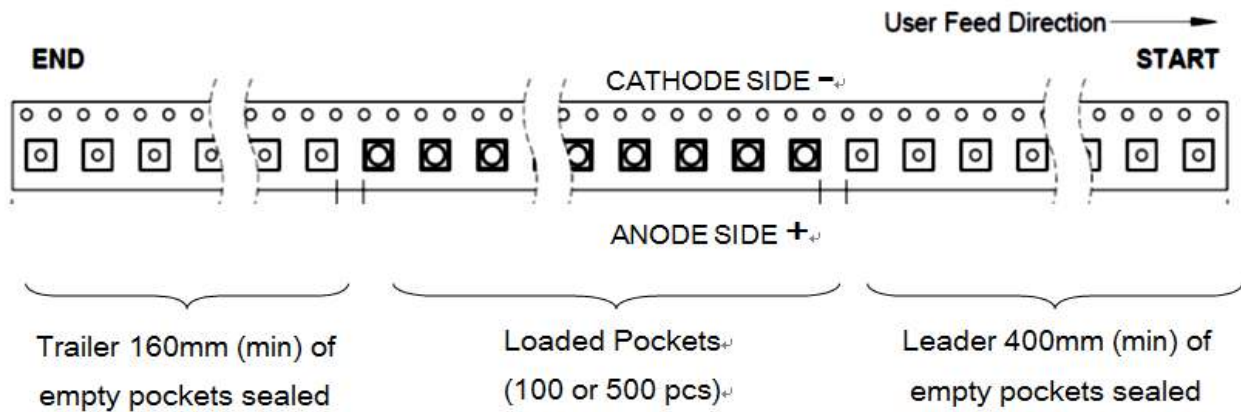
1. Do not stress the silicone resin while it is exposed to high temperature.
2. The number of reflow process should not exceed 3 times.

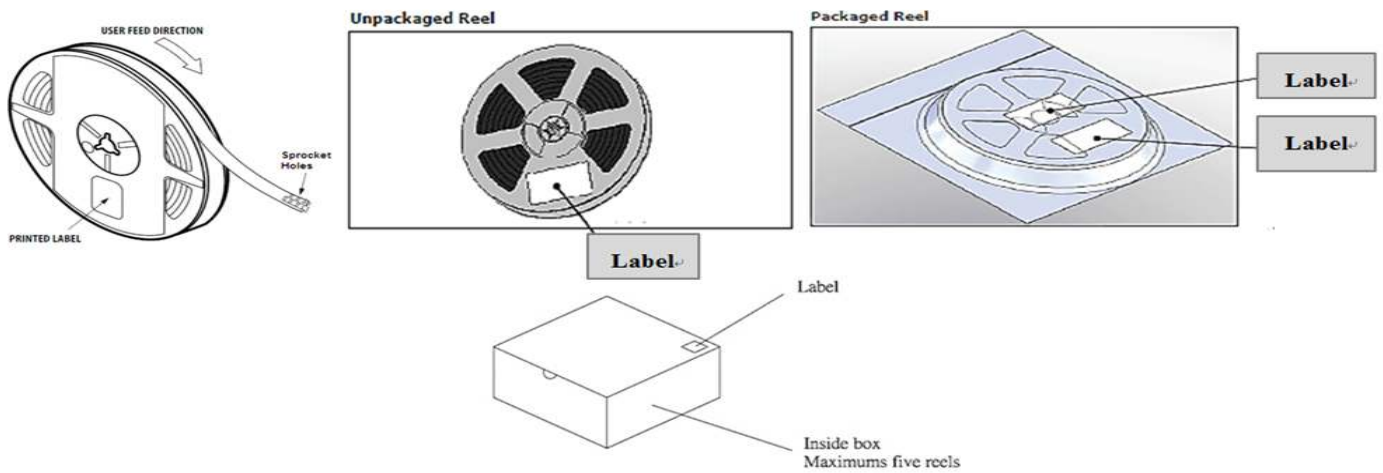
Packing

The carrier tape conforms to EIA-481D.



W	A0	B0	K0
12.00±0.30	4.20±0.10	4.20±0.10	2.90±0.10





Notes:

1. Each Reel (minimum number of pieces is 100 and maximum is 500(30D/60D/120D) packed in a moisture-proof bag along with 2 packs of desiccant and a humidity indicator card.
2. A maximum of 5 moisture-proof bags are packed in an inner box (size: 240mm x 200mm x 105mm \pm 5mm).
3. A maximum of 4 inner boxes are put in an outer box (size: 410mm x 255mm x 230mm \pm 5mm).
4. Part No., Lot No., quantity should be indicated on the label of the moisture-proof bag and the cardboard box.

Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release		1.0	02-03-2019
Revise The Drawing and Parameters	2, 4	1.1	05-13-2019

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